

ROP

COMPLIANT HALOGEN

FREE

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**Vishay Siliconix** 

## N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
100	0.158 at V <sub>GS</sub> = 10 V	3.8	4.6 nC			
100	0.175 at V <sub>GS</sub> = 6 V	3.6	4.0110			

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- High Frequency Boost Converter
- LED Backlight for LCD TV





Ordering Information: Si4102DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

GC S

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C, unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	100	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20	v		
	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	3.8			
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		3			
	T <sub>A</sub> = 25 °C		2.7 <sup>a, b</sup>			
	T <sub>A</sub> = 70 °C		2.1 <sup>a, b</sup>	A		
Pulsed Drain Current		I <sub>DM</sub>	8			
Continuous Courses Drain Diado Current	T <sub>C</sub> = 25 °C	1	4			
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	2 <sup>a, b</sup>			
Single Avalanche CurrentL = 0.1 mHSingle Avalanche Energy		I <sub>AS</sub>	6	A		
		E <sub>AS</sub>	1.8	mJ		
	T <sub>C</sub> = 25 °C	- P <sub>D</sub>	4.8			
Maximum Power Dissipation	T <sub>C</sub> = 70 °C		3	w		
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C	'D	2.4 <sup>a, b</sup>	vv		
	T <sub>A</sub> = 70 °C	1	1.5 <sup>a, b</sup>			
Operating Junction and Storage Temperature	e Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	42	53	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	21	26	0/10		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under steady state conditions is 85 °C/W.

d. Based on  $T_C = 25$  °C.

Document Number: 69252 For technical questions, contact: pmostechsupport@vishay.com www.vishay.com S13-0631-Rev. C, 25-Mar-13

## Si4102DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static					1	1
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050 4		110		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 7.5		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2		4	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
7 0		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
Zero Gate Voltage Drain Current	IDSS	$V_{DS}$ = 100 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5$ V, $V_{GS} = 10$ V	8			Α
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.7 A		0.130	0.158	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 6 V, I_D = 2.5 A$			0.175	Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 2.7 \text{ A}$		7		S
Dynamic <sup>b</sup>		-		1	1	1
Input Capacitance	C <sub>iss</sub>			370		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		40		
Reverse Transfer Capacitance	C <sub>rss</sub>			20		
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 50$ V, $V_{GS} = 10$ V, $I_{D} = 2.7$ A		7.1	11	nC
				4.6	7	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 50$ V, $V_{GS} = 6$ V, $I_{D} = 2.7$ A		1.7		
Gate-Drain Charge	Q <sub>gd</sub>			2		
Gate Resistance	Rg	f = 1 MHz		3		Ω
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	-
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_L$ = 23.8 $\Omega$		10	15	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong\text{2.1}$ A, $\text{V}_\text{GEN}$ = 6 V, $\text{R}_\text{g}$ = 1 $\Omega$		10	15	
Fall Time	t <sub>f</sub>			10	15	
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	ns
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, \text{ R}_{L} = 23.8 \Omega$		10	15	-
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D} \cong$ 2.1 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		12	20	
Fall Time	t <sub>f</sub>			10	15	
Drain-Source Body Diode Characteristic	cs			1	1	
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			4	•
Pulse Diode Forward Current	I <sub>SM</sub>				8	A
Body Diode Voltage	V <sub>SD</sub>	$I_{S} = 2.1 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			50	80	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			75	120	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 2.1 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		28		
Reverse Recovery Rise Time	t <sub>b</sub>			22		ns

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Document Number: 69252 S13-0631-Rev. C, 25-Mar-13



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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## Si4102DY

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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Si4102DY Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?69252">www.vishay.com/ppg?69252</a>.

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# Package Information

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# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

# **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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